

Adjustable 1.1A Single Resistor Low Dropout Regulator

FEATURES

- Outputs May be Paralleled for Higher Current and Heat Spreading
- Output Current: 1.1A
- Single Resistor Programs Output Voltage
- 1% Initial Accuracy of SET Pin Current
- Output Adjustable to 0V
- Low Output Noise: 40 μ V_{RMS} (10Hz to 100kHz)
- Wide Input Voltage Range: 1.2V to 36V
- Low Dropout Voltage: 350mV (Except SOT-223 Package)
- <1mV Load Regulation
- <0.001%/V Line Regulation
- Minimum Load Current: 0.5mA
- Stable with 2.2 μ F Minimum Ceramic Output Capacitor
- Current Limit with Foldback and Overtemperature Protected
- Available in 8-Lead MSOP, 3mm $\times$ 3mm DFN, 5-Lead DD-Pak, TO-220 and 3-Lead SOT-223

APPLICATIONS

- High Current All Surface Mount Supply
- High Efficiency Linear Regulator
- Post Regulator for Switching Supplies
- Low Parts Count Variable Voltage Supply
- Low Output Voltage Power Supplies

DESCRIPTION

The LT[®]3080 is a 1.1A low dropout linear regulator that can be paralleled to increase output current or spread heat in surface mounted boards. Architected as a precision current source and voltage follower allows this new regulator to be used in many applications requiring high current, adjustability to zero, and no heat sink. Also the device brings out the collector of the pass transistor to allow low dropout operation—down to 350 millivolts—when used with multiple supplies.

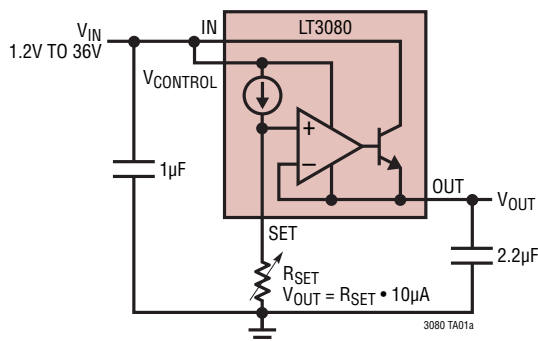
A key feature of the LT3080 is the capability to supply a wide output voltage range. By using a reference current through a single resistor, the output voltage is programmed to any level between zero and 36V. The LT3080 is stable with 2.2 μ F of capacitance on the output, and the IC uses small ceramic capacitors that do not require additional ESR as is common with other regulators.

Internal protection circuitry includes current limiting and thermal limiting. The LT3080 regulator is offered in the 8-lead MSOP (with an exposed pad for better thermal characteristics), a 3mm $\times$ 3mm DFN, 5-lead DD-Pak, TO-220 and a simple-to-use 3-lead SOT-223 version.

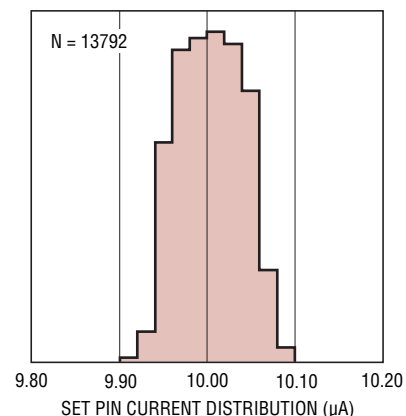
LT, LT[®], LTC, LTM, Linear Technology and the Linear logo are registered trademarks and VLDO and ThinSOT are trademarks of Linear Technology Corporation. All other trademarks are the property of their respective owners.

TYPICAL APPLICATION

Variable Output Voltage 1.1A Supply



Set Pin Current Distribution



3080 G02

3080fc

ABSOLUTE MAXIMUM RATINGS (Note 1)(All Voltages Relative to V_{OUT})

$V_{CONTROL}$ Pin Voltage.....	40V, -0.3V	Operating Junction Temperature Range (Notes 2, 10)	
IN Pin Voltage	40V, -0.3V	E-, I-Grades.....	-40°C to 125°C
SET Pin Current (Note 7)	±10mA	Storage Temperature Range:.....	-65°C to 150°C
SET Pin Voltage (Relative to OUT)	±0.3V	Lead Temperature (Soldering, 10 sec)	
Output Short-Circuit Duration	Indefinite	MS8E, Q, T and ST Packages Only.....	300°C

PIN CONFIGURATION

TOP VIEW OUT 1 OUT 2 OUT 3 SET 4 8 IN 7 IN 6 NC 5 VCONTROL 9 OUT DD PACKAGE 8-LEAD (3mm × 3mm) PLASTIC DFN $T_{JMAX} = 125^{\circ}\text{C}$, $\theta_{JA} = 64^{\circ}\text{C/W}$, $\theta_{JC} = 3^{\circ}\text{C/W}$ EXPOSED PAD (PIN 9) IS OUT, MUST BE SOLDERED TO PCB	TOP VIEW OUT 1 OUT 2 OUT 3 SET 4 8 IN 7 IN 6 NC 5 VCONTROL 9 OUT MS8E PACKAGE 8-LEAD PLASTIC MSOP $T_{JMAX} = 125^{\circ}\text{C}$, $\theta_{JA} = 60^{\circ}\text{C/W}$, $\theta_{JC} = 10^{\circ}\text{C/W}$ EXPOSED PAD (PIN 9) IS OUT, MUST BE SOLDERED TO PCB	FRONT VIEW TAB IS OUT 5 IN 4 VCONTROL 3 OUT 2 SET 1 NC Q PACKAGE 5-LEAD PLASTIC DD-PAK $T_{JMAX} = 125^{\circ}\text{C}$, $\theta_{JA} = 30^{\circ}\text{C/W}$, $\theta_{JC} = 3^{\circ}\text{C/W}$
FRONT VIEW TAB IS OUT 5 IN 4 VCONTROL 3 OUT 2 SET 1 NC T PACKAGE 5-LEAD PLASTIC TO-220 $T_{JMAX} = 125^{\circ}\text{C}$, $\theta_{JA} = 40^{\circ}\text{C/W}$, $\theta_{JC} = 3^{\circ}\text{C/W}$	FRONT VIEW TAB IS OUT 3 IN* 2 OUT 1 SET ST PACKAGE 3-LEAD PLASTIC SOT-223 *IN IS VCONTROL AND IN TIED TOGETHER $T_{JMAX} = 125^{\circ}\text{C}$, $\theta_{JA} = 55^{\circ}\text{C/W}$, $\theta_{JC} = 15^{\circ}\text{C/W}$	

ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT3080EDD#PBF	LT3080EDD#TRPBF	LCBN	8-Lead (3mm x 3mm) Plastic DFN	-40°C to 125°C
LT3080IDD#PBF	LT3080IDD#TRPBF	LCBN	8-Lead (3mm x 3mm) Plastic DFN	-40°C to 125°C
LT3080EMS8E#PBF	LT3080EMS8E#TRPBF	LTCBM	8-Lead Plastic MSOP	-40°C to 125°C
LT3080IMS8E#PBF	LT3080IMS8E#TRPBF	LTCBM	8-Lead Plastic MSOP	-40°C to 125°C
LT3080EQ#PBF	LT3080EQ#TRPBF	LT3080Q	5-Lead Plastic DD-Pak	-40°C to 125°C
LT3080IQ#PBF	LT3080IQ#TRPBF	LT3080Q	5-Lead Plastic DD-Pak	-40°C to 125°C
LT3080ET#PBF	LT3080ET#TRPBF	LT3080ET	5-Lead Plastic TO-220	-40°C to 125°C
LT3080IT#PBF	LT3080IT#TRPBF	LT3080ET	5-Lead Plastic TO-220	-40°C to 125°C
LT3080EST#PBF	LT3080EST#TRPBF	3080	3-Lead Plastic SOT-223	-40°C to 125°C
LT3080IST#PBF	LT3080IST#TRPBF	3080	3-Lead Plastic SOT-223	-40°C to 125°C
LEAD BASED FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT3080EDD	LT3080EDD#TR	LCBN	8-Lead (3mm x 3mm) Plastic DFN	-40°C to 125°C
LT3080IDD	LT3080IDD#TR	LCBN	8-Lead (3mm x 3mm) Plastic DFN	-40°C to 125°C
LT3080EMS8E	LT3080EMS8E#TR	LTCBM	8-Lead Plastic MSOP	-40°C to 125°C
LT3080IMS8E	LT3080IMS8E#TR	LTCBM	8-Lead Plastic MSOP	-40°C to 125°C
LT3080EQ	LT3080EQ#TR	LT3080Q	5-Lead Plastic DD-Pak	-40°C to 125°C
LT3080IQ	LT3080IQ#TR	LT3080Q	5-Lead Plastic DD-Pak	-40°C to 125°C
LT3080ET	LT3080ET#TR	LT3080ET	5-Lead Plastic TO-220	-40°C to 125°C
LT3080IT	LT3080IT#TR	LT3080ET	5-Lead Plastic TO-220	-40°C to 125°C
LT3080EST	LT3080EST#TR	3080	3-Lead Plastic SOT-223	-40°C to 125°C
LT3080IST	LT3080IST#TR	3080	3-Lead Plastic SOT-223	-40°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandree/>

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 11)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
SET Pin Current	I_{SET} $V_{IN} = 1\text{V}$, $V_{CONTROL} = 2.0\text{V}$, $I_{LOAD} = 1\text{mA}$, $T_J = 25^\circ\text{C}$ $V_{IN} \geq 1\text{V}$, $V_{CONTROL} \geq 2.0\text{V}$, $1\text{mA} \leq I_{LOAD} \leq 1.1\text{A}$ (Note 9)	9.90	10	10.10	μA
Output Offset Voltage ($V_{OUT} - V_{SET}$)	V_{OS} DFN and MSOP Package	● -2		2	mV
$V_{IN} = 1\text{V}$, $V_{CONTROL} = 2\text{V}$, $I_{OUT} = 1\text{mA}$		● -3.5		3.5	mV
	SOT-223, DD-Pak and T0-220 Package	● -5		5	mV
		● -6		6	mV
Load Regulation	ΔI_{SET} $\Delta I_{LOAD} = 1\text{mA}$ to 1.1A ΔV_{OS} $\Delta I_{LOAD} = 1\text{mA}$ to 1.1A (Note 8)	●	-0.1		nA
		●	0.6	1.3	mV
Line Regulation (Note 9)	ΔI_{SET} $V_{IN} = 1\text{V}$ to 25V, $V_{CONTROL} = 2\text{V}$ to 25V, $I_{LOAD} = 1\text{mA}$ ΔV_{OS} $V_{IN} = 1\text{V}$ to 25V, $V_{CONTROL} = 2\text{V}$ to 25V, $I_{LOAD} = 1\text{mA}$	●	0.1	0.5	nA/V
			0.003		mV/V
Line Regulation (Note 9)	ΔI_{SET} $V_{IN} = 1\text{V}$ to 26V, $V_{CONTROL} = 2\text{V}$ to 26V, $I_{LOAD} = 1\text{mA}$ ΔV_{OS} $V_{IN} = 1\text{V}$ to 26V, $V_{CONTROL} = 2\text{V}$ to 26V, $I_{LOAD} = 1\text{mA}$	●	0.1	0.5	nA/V
			0.003		mV/V
Minimum Load Current (Notes 3, 9)	$V_{IN} = V_{CONTROL} = 10\text{V}$ $V_{IN} = V_{CONTROL} = 25\text{V}$ (DFN and MSOP Package) $V_{IN} = V_{CONTROL} = 26\text{V}$ (SOT-223, DD-Pak and T0-220 Package)	●	300	500	μA
		●		1	mA
		●		1	mA
$V_{CONTROL}$ Dropout Voltage (Note 4)	$I_{LOAD} = 100\text{mA}$ $I_{LOAD} = 1.1\text{A}$	●	1.2		V
		●	1.35	1.6	V
V_{IN} Dropout Voltage (Note 4)	$I_{LOAD} = 100\text{mA}$ $I_{LOAD} = 1.1\text{A}$	●	100	200	mV
		●	350	500	mV
$V_{CONTROL}$ Pin Current	$I_{LOAD} = 100\text{mA}$ $I_{LOAD} = 1.1\text{A}$	●	4	6	mA
		●	17	30	mA
Current Limit	$V_{IN} = 5\text{V}$, $V_{CONTROL} = 5\text{V}$, $V_{SET} = 0\text{V}$, $V_{OUT} = -0.1\text{V}$	●	1.1	1.4	A
Error Amplifier RMS Output Noise (Note 6)	$I_{LOAD} = 1.1\text{A}$, $10\text{Hz} \leq f \leq 100\text{kHz}$, $C_{OUT} = 10\mu\text{F}$, $C_{SET} = 0.1\mu\text{F}$		40		μV_{RMS}
Reference Current RMS Output Noise (Note 6)	$10\text{Hz} \leq f \leq 100\text{kHz}$		1		nA _{RMS}
Ripple Rejection	$f = 120\text{Hz}$, $V_{RIPPLE} = 0.5\text{V}_{P-P}$, $I_{LOAD} = 0.2\text{A}$, $C_{SET} = 0.1\mu\text{F}$, $C_{OUT} = 2.2\mu\text{F}$ $f = 10\text{kHz}$ $f = 1\text{MHz}$		75		dB
			55		dB
			20		dB
Thermal Regulation, I_{SET}	10ms Pulse		0.003		%/W

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: Unless otherwise specified, all voltages are with respect to V_{OUT} . The LT3080 is tested and specified under pulse load conditions such that $T_J \cong T_A$. The LT3080E is tested at $T_A = 25^\circ\text{C}$. Performance of the LT3080E over the full -40°C and 125°C operating temperature range is assured by design, characterization, and correlation with statistical process controls. The LT3080I is guaranteed over the full -40°C to 125°C operating junction temperature range.

Note 3: Minimum load current is equivalent to the quiescent current of the part. Since all quiescent and drive current is delivered to the output of the part, the minimum load current is the minimum current required to maintain regulation.

Note 4: For the LT3080, dropout is caused by either minimum control voltage ($V_{CONTROL}$) or minimum input voltage (V_{IN}). Both parameters are specified with respect to the output voltage. The specifications represent the minimum input-to-output differential voltage required to maintain regulation.

Note 5: The $V_{CONTROL}$ pin current is the drive current required for the output transistor. This current will track output current with roughly a 1:60 ratio. The minimum value is equal to the quiescent current of the device.

Note 6: Output noise is lowered by adding a small capacitor across the voltage setting resistor. Adding this capacitor bypasses the voltage setting resistor shot noise and reference current noise; output noise is then equal to error amplifier noise (see Applications Information section).

Note 7: SET pin is clamped to the output with diodes. These diodes only carry current under transient overloads.

Note 8: Load regulation is Kelvin sensed at the package.

Note 9: Current limit may decrease to zero at input-to-output differential voltages ($V_{IN} - V_{OUT}$) greater than 25V (DFN and MSOP package) or 26V (SOT-223, DD-Pak and T0-220 Package). Operation at voltages for both I_{IN} and $V_{CONTROL}$ is allowed up to a maximum of 36V as long as the difference between input and output voltage is below the specified differential ($V_{IN} - V_{OUT}$) voltage. Line and load regulation specifications are not applicable when the device is in current limit.

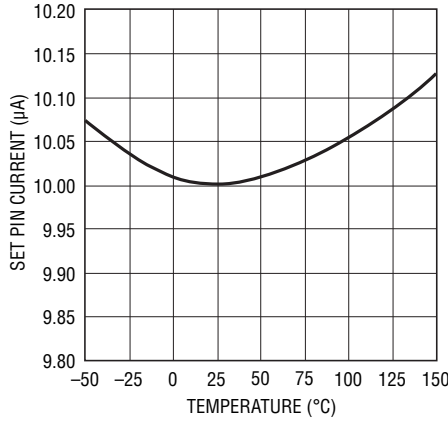
Note 10: This IC includes overtemperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed the maximum operating junction temperature when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature may impair device reliability.

Note 11: The SOT-223 package connects the I_{IN} and $V_{CONTROL}$ pins together internally. Therefore, test conditions for this pin follow the $V_{CONTROL}$ conditions listed in the Electrical Characteristics Table.

3080fc

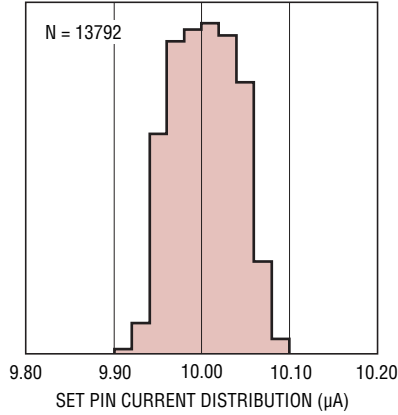
TYPICAL PERFORMANCE CHARACTERISTICS

Set Pin Current



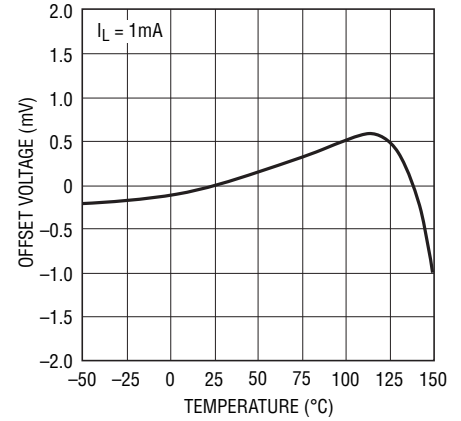
3080 G01

Set Pin Current Distribution



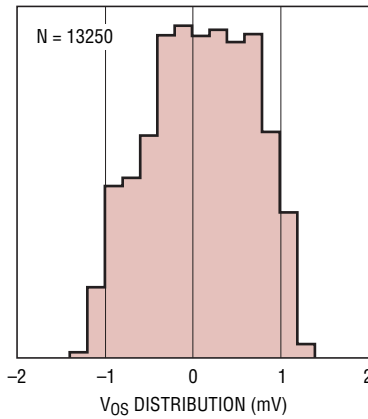
3080 G02

Offset Voltage ($V_{\text{OUT}} - V_{\text{SET}}$)



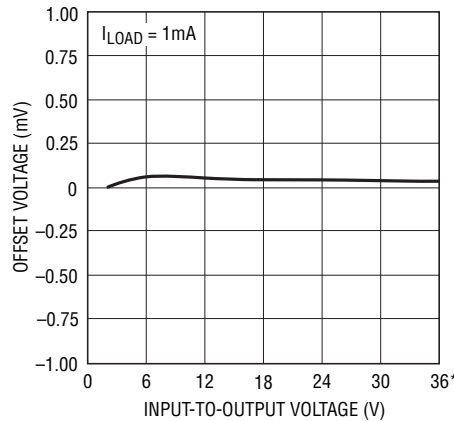
3080 G03

Offset Voltage Distribution



3080 G04

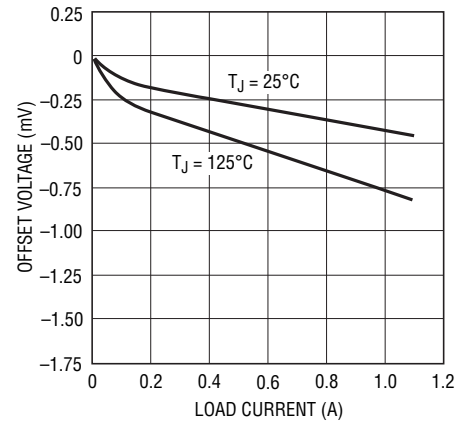
Offset Voltage



3080 G05

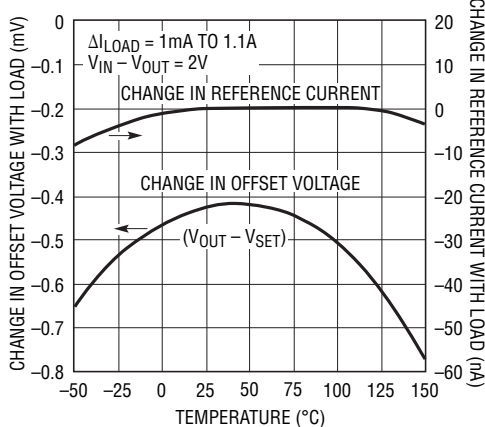
*SEE NOTE 9 IN ELECTRICAL CHARACTERISTICS TABLE

Offset Voltage



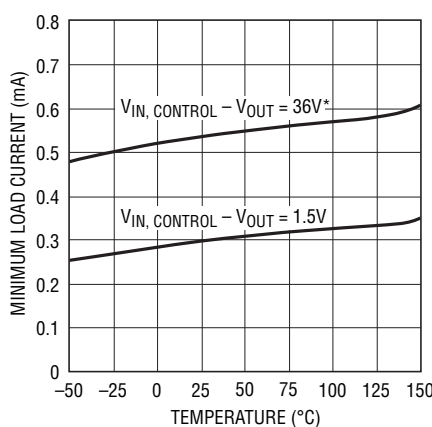
3080 G06

Load Regulation



3080 G07

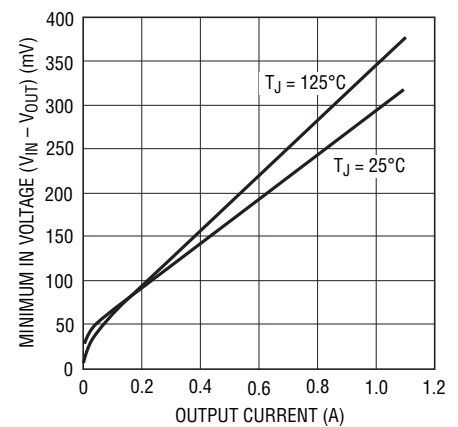
Minimum Load Current



3080 G08

*SEE NOTE 9 IN ELECTRICAL CHARACTERISTICS TABLE

Dropout Voltage (Minimum IN Voltage)

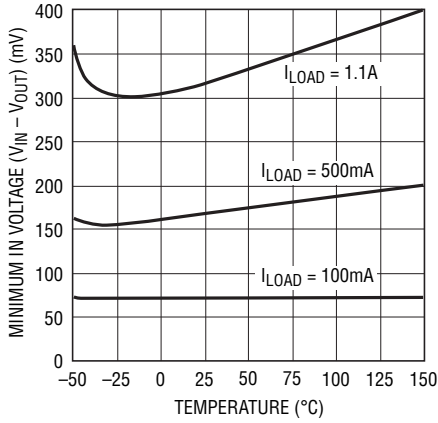


3080 G09

3080fc

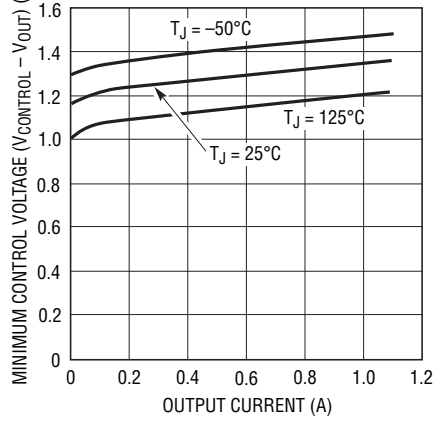
TYPICAL PERFORMANCE CHARACTERISTICS

Dropout Voltage (Minimum IN Voltage)



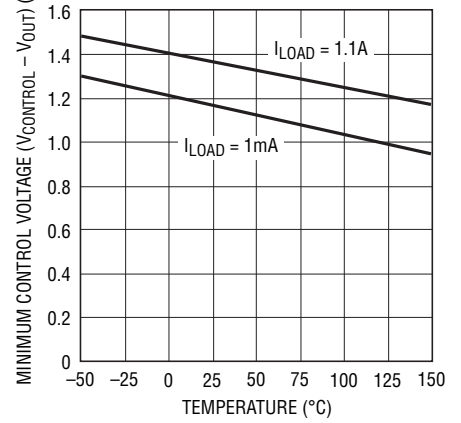
3080 G10

Dropout Voltage (Minimum VCONTROL Pin Voltage)



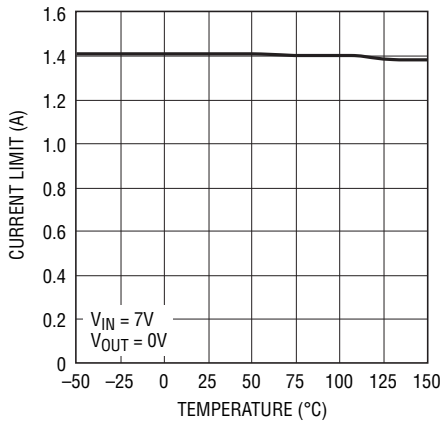
3080 G11

Dropout Voltage (Minimum VCONTROL Pin Voltage)



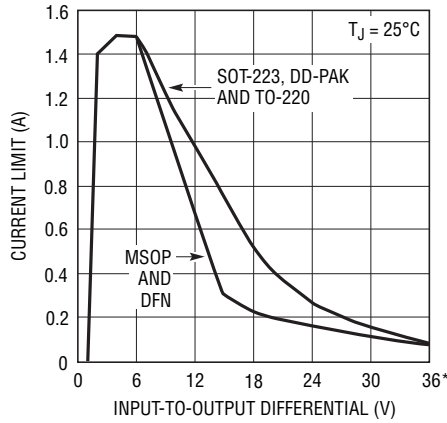
3080 G12

Current Limit



3080 G13

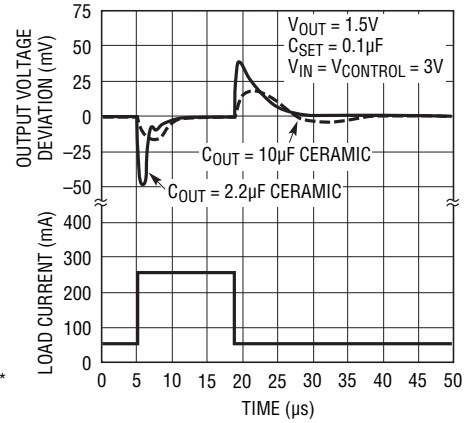
Current Limit



*SEE NOTE 9 IN ELECTRICAL CHARACTERISTICS TABLE

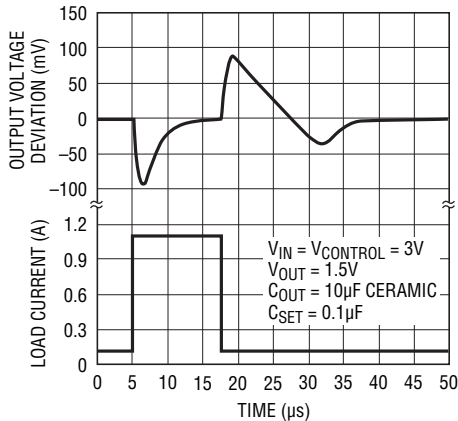
3080 G14

Load Transient Response



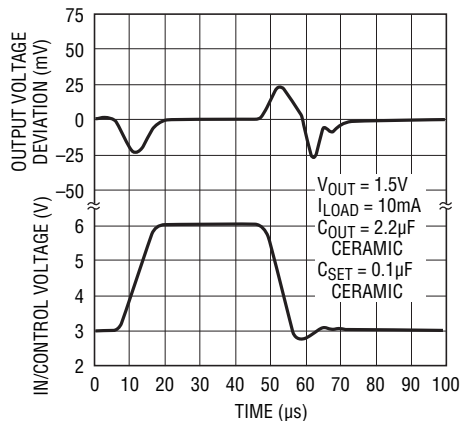
3080 G15

Load Transient Response



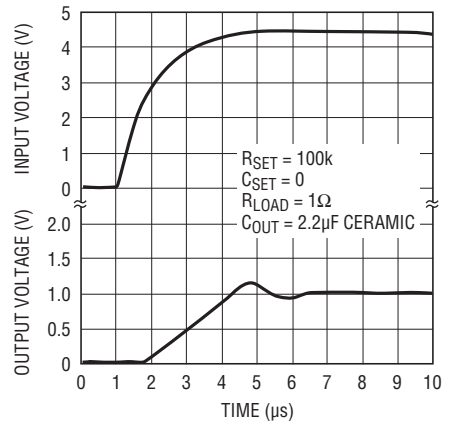
3080 G16

Line Transient Response



3080 G17

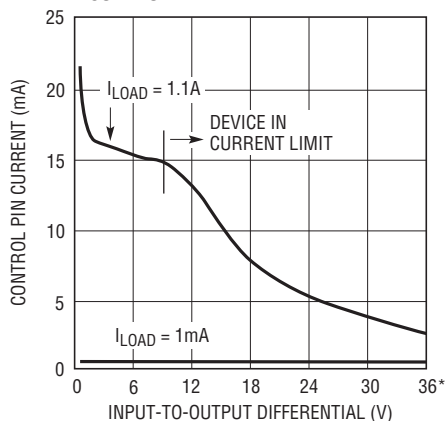
Turn-On Response



3080 G18

TYPICAL PERFORMANCE CHARACTERISTICS

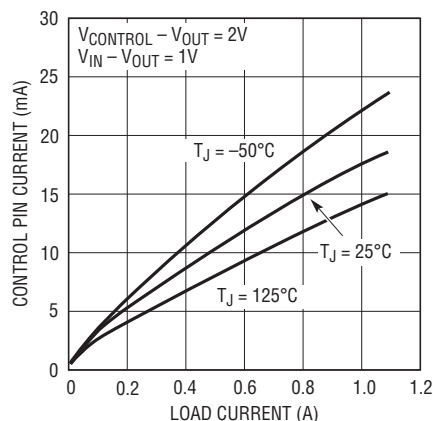
V_{CONTROL} Pin Current



*SEE NOTE 9 IN ELECTRICAL CHARACTERISTICS TABLE

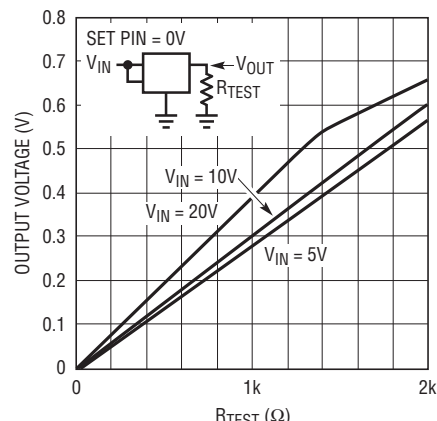
3080 G19

V_{CONTROL} Pin Current



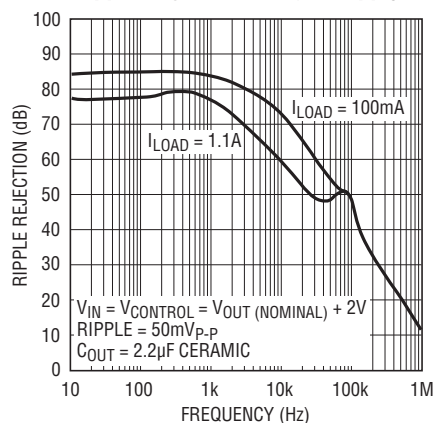
3080 G20

Residual Output Voltage with Less Than Minimum Load



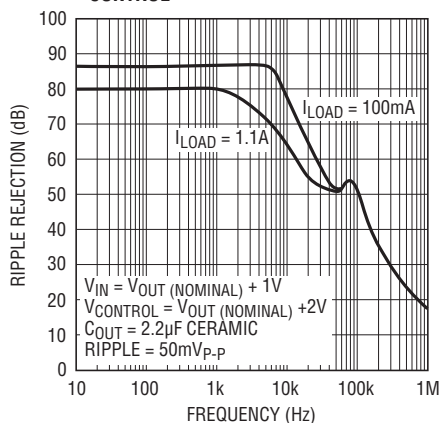
3080 G21

Ripple Rejection, Single Supply



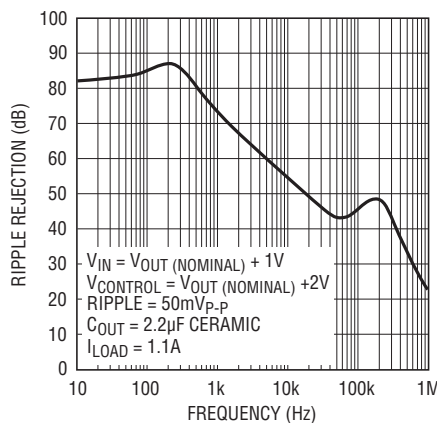
3080 G22

Ripple Rejection, Dual Supply, V_{CONTROL} Pin



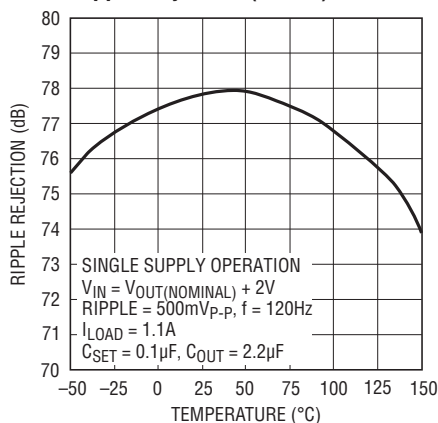
3080 G23

Ripple Rejection, Dual Supply, IN Pin



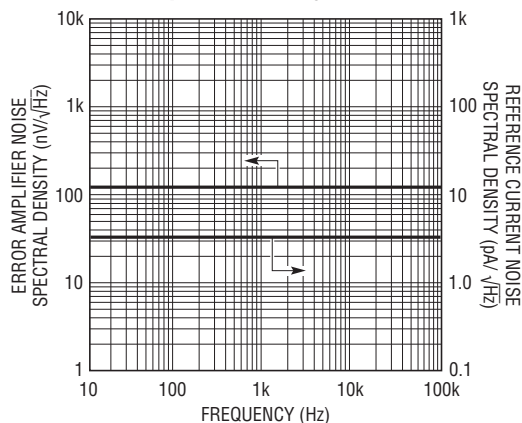
3080 G24

Ripple Rejection (120Hz)



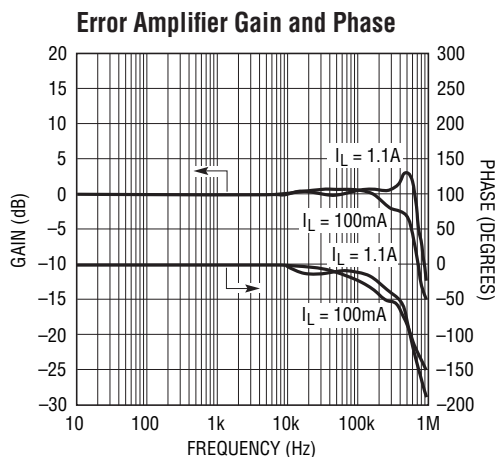
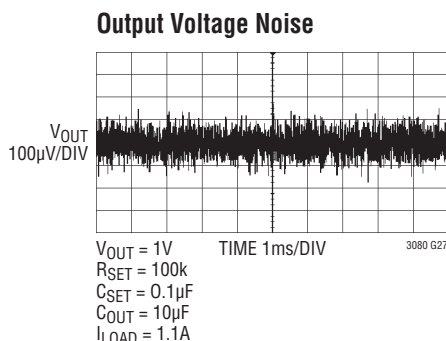
3080 G25

Noise Spectral Density



3080 G26

TYPICAL PERFORMANCE CHARACTERISTICS



PIN FUNCTIONS (DD/MS8E/Q/T/ST)

$V_{CONTROL}$ (Pin 5/Pin 5/Pin 4/Pin 4/NA): This pin is the supply pin for the control circuitry of the device. The current flow into this pin is about 1.7% of the output current. For the device to regulate, this voltage must be more than 1.2V to 1.35V greater than the output voltage (see dropout specifications).

IN (Pins 7, 8/Pins 7, 8/Pin 5/Pin 5/Pin 3): This is the collector to the power device of the LT3080. The output load current is supplied through this pin. For the device to regulate, the voltage at this pin must be more than 0.1V to 0.5V greater than the output voltage (see dropout specifications).

NC (Pin 6/Pin 6/Pin 1/Pin 1/NA): No Connection. No connect pins have no connection to internal circuitry and may be tied to V_{IN} , $V_{CONTROL}$, V_{OUT} , GND or floated.

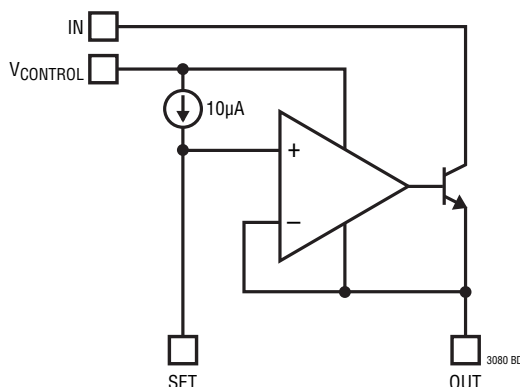
OUT (Pins 1-3/Pins 1-3/Pin 3/Pin 3/Pin 2): This is the power output of the device. There must be a minimum load current of 1mA or the output may not regulate.

SET (Pin 4/Pin 4/Pin 2/Pin 2/Pin 1): This pin is the input to the error amplifier and the regulation set point for the device. A fixed current of 10 μA flows out of this pin through a single external resistor, which programs the output voltage of the device. Output voltage range is zero to the absolute maximum rated output voltage. Transient performance can be improved by adding a small capacitor from the SET pin to ground.

Exposed Pad (Pin 9/Pin 9/NA/NA/NA): OUT on MS8E and DFN packages.

TAB: OUT on DD-Pak, TO-220 and SOT-223 packages.

BLOCK DIAGRAM



APPLICATIONS INFORMATION

The LT3080 regulator is easy to use and has all the protection features expected in high performance regulators. Included are short-circuit protection and safe operating area protection, as well as thermal shutdown.

The LT3080 is especially well suited to applications needing multiple rails. The new architecture adjusts down to zero with a single resistor handling modern low voltage digital IC's as well as allowing easy parallel operation and thermal management without heat sinks. Adjusting to "zero" output allows shutting off the powered circuitry and when the input is pre-regulated—such as a 5V or 3.3V input supply—external resistors can help spread the heat.

A precision "0" TC 10µA internal current source is connected to the noninverting input of a power operational amplifier. The power operational amplifier provides a low impedance buffered output to the voltage on the noninverting input. A single resistor from the noninverting input to ground sets the output voltage and if this resistor is set to zero, zero output results. As can be seen, any output voltage can be obtained from zero up to the maximum defined by the input power supply.

What is not so obvious from this architecture are the benefits of using a true internal current source as the reference as opposed to a bootstrapped reference in older regulators. A true current source allows the regulator to have gain and frequency response independent of the impedance on the positive input. Older adjustable regulators, such as the

LT1086 have a change in loop gain with output voltage as well as bandwidth changes when the adjustment pin is bypassed to ground. For the LT3080, the loop gain is unchanged by changing the output voltage or bypassing. Output regulation is not fixed at a percentage of the output voltage but is a fixed fraction of millivolts. Use of a true current source allows all the gain in the buffer amplifier to provide regulation and none of that gain is needed to amplify up the reference to a higher output voltage.

The LT3080 has the collector of the output transistor connected to a separate pin from the control input. Since the dropout on the collector (IN pin) is only 350mV, two supplies can be used to power the LT3080 to reduce dissipation: a higher voltage supply for the control circuitry and a lower voltage supply for the collector. This increases efficiency and reduces dissipation. To further spread the heat, a resistor can be inserted in series with the collector to move some of the heat out of the IC and spread it on the PC board.

The LT3080 can be operated in two modes. Three-terminal mode has the control pin connected to the power input pin which gives a limitation of 1.35V dropout. Alternatively, the "control" pin can be tied to a higher voltage and the power IN pin to a lower voltage giving 350mV dropout on the IN pin and minimizing the power dissipation. This allows for a 1.1A supply regulating from 2.5V_{IN} to 1.8V_{OUT} or 1.8V_{IN} to 1.2V_{OUT} with low dissipation.

APPLICATIONS INFORMATION

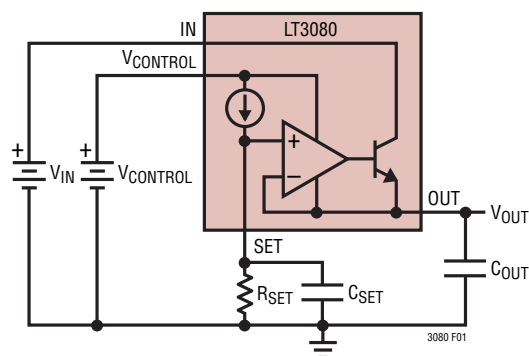


Figure 1. Basic Adjustable Regulator

Output Voltage

The LT3080 generates a 10 μ A reference current that flows out of the SET pin. Connecting a resistor from SET to ground generates a voltage that becomes the reference point for the error amplifier (see Figure 1). The reference voltage is a straight multiplication of the SET pin current and the value of the resistor. Any voltage can be generated and there is no minimum output voltage for the regulator. A minimum load current of 1mA is required to maintain regulation regardless of output voltage. For true zero voltage output operation, this 1mA load current must be returned to a negative supply voltage.

With the low level current used to generate the reference voltage, leakage paths to or from the SET pin can create errors in the reference and output voltages. High quality insulation should be used (e.g., Teflon, Kel-F); cleaning of all insulating surfaces to remove fluxes and other residues will probably be required. Surface coating may be necessary to provide a moisture barrier in high humidity environments.

Board leakage can be minimized by encircling the SET pin and circuitry with a guard ring operated at a potential close to itself; the guard ring should be tied to the OUT pin. Guarding both sides of the circuit board is required. Bulk leakage reduction depends on the guard ring width. Ten nanoamperes of leakage into or out of the SET pin and associated circuitry creates a 0.1% error in the reference voltage. Leakages of this magnitude, coupled with other sources of leakage, can cause significant offset voltage and reference drift, especially over the possible operating temperature range.

If guarding techniques are used, this bootstraps any stray capacitance at the SET pin. Since the SET pin is a high impedance node, unwanted signals may couple into the SET pin and cause erratic behavior. This will be most noticeable when operating with minimum output capacitors at full load current. The easiest way to remedy this is to bypass the SET pin with a small amount of capacitance from SET to ground, 10pF to 20pF is sufficient.

Stability and Output Capacitance

The LT3080 requires an output capacitor for stability. It is designed to be stable with most low ESR capacitors (typically ceramic, tantalum or low ESR electrolytic). A minimum output capacitor of 2.2 μ F with an ESR of 0.5 Ω or less is recommended to prevent oscillations. Larger values of output capacitance decrease peak deviations and provide improved transient response for larger load current changes. Bypass capacitors, used to decouple individual components powered by the LT3080, increase the effective output capacitor value.

For improvement in transient performance, place a capacitor across the voltage setting resistor. Capacitors up to 1 μ F can be used. This bypass capacitor reduces system noise as well, but start-up time is proportional to the time constant of the voltage setting resistor (R_{SET} in Figure 1) and SET pin bypass capacitor.

Extra consideration must be given to the use of ceramic capacitors. Ceramic capacitors are manufactured with a variety of dielectrics, each with different behavior across temperature and applied voltage. The most common dielectrics used are specified with EIA temperature characteristic codes of Z5U, Y5V, X5R and X7R. The Z5U and Y5V dielectrics are good for providing high capacitances in a small package, but they tend to have strong voltage and temperature coefficients as shown in Figures 2 and 3. When used with a 5V regulator, a 16V 10 μ F Y5V capacitor can exhibit an effective value as low as 1 μ F to 2 μ F for the DC bias voltage applied and over the operating temperature range. The X5R and X7R dielectrics result in more stable characteristics and are more suitable for use as the output capacitor. The X7R type has better stability across temperature, while the X5R is less expensive and is

APPLICATIONS INFORMATION

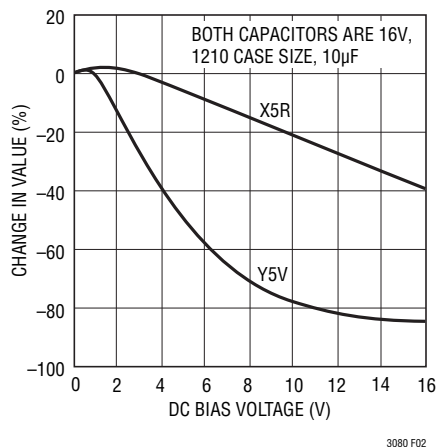


Figure 2. Ceramic Capacitor DC Bias Characteristics

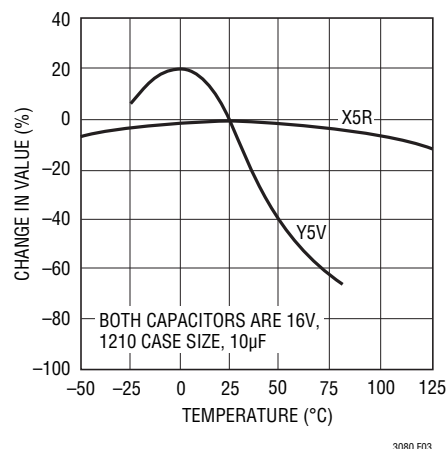


Figure 3. Ceramic Capacitor Temperature Characteristics

available in higher values. Care still must be exercised when using X5R and X7R capacitors; the X5R and X7R codes only specify operating temperature range and maximum capacitance change over temperature. Capacitance change due to DC bias with X5R and X7R capacitors is better than Y5V and Z5U capacitors, but can still be significant enough to drop capacitor values below appropriate levels. Capacitor DC bias characteristics tend to improve as component case size increases, but expected capacitance at operating voltage should be verified.

Voltage and temperature coefficients are not the only sources of problems. Some ceramic capacitors have a piezoelectric response. A piezoelectric device generates voltage across its terminals due to mechanical stress, similar to the way a piezoelectric microphone works. For a

ceramic capacitor the stress can be induced by vibrations in the system or thermal transients.

Paralleling Devices

LT3080's may be paralleled to obtain higher output current. The SET pins are tied together and the IN pins are tied together. This is the same whether it's in three terminal mode or has separate input supplies. The outputs are connected in common using a small piece of PC trace as a ballast resistor to equalize the currents. PC trace resistance in milliohms/inch is shown in Table 1. Only a tiny area is needed for ballasting.

Table 1. PC Board Trace Resistance

WEIGHT (oz)	10 mil WIDTH	20 mil WIDTH
1	54.3	27.1
2	27.1	13.6

Trace resistance is measured in mOhms/in

The worse case offset between the set pin and the output of only ± 2 millivolts allows very small ballast resistors to be used. As shown in Figure 4, the two devices have a small 10 milliohm ballast resistor, which at full output current gives better than 80 percent equalized sharing of the current. The external resistance of 10 milliohms

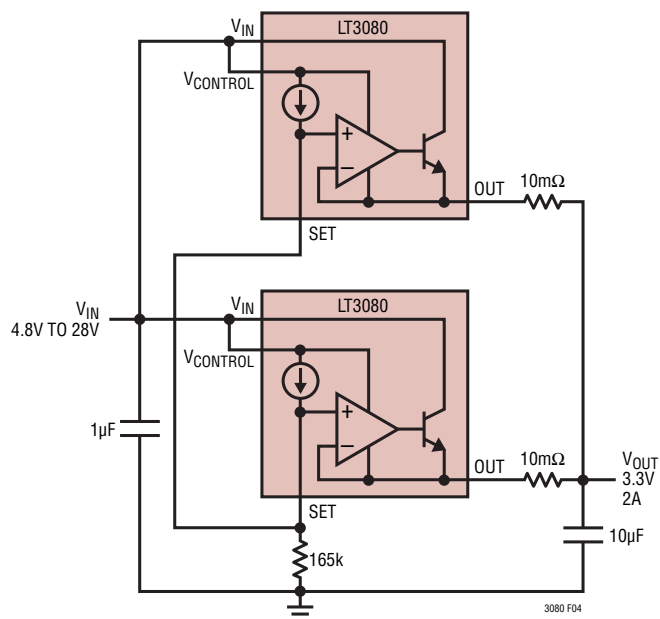


Figure 4. Parallel Devices

APPLICATIONS INFORMATION

(5 milliohms for the two devices in parallel) only adds about 10 millivolts of output regulation drop at an output of 2A. Even with an output voltage as low as 1V, this only adds 1% to the regulation. Of course, more than two LT3080's can be paralleled for even higher output current. They are spread out on the PC board, spreading the heat. Input resistors can further spread the heat if the input-to-output difference is high.

Thermal Performance

In this example, two LT3080 3mm × 3mm DFN devices are mounted on a 1oz copper 4-layer PC board. They are placed approximately 1.5 inches apart and the board is mounted vertically for convection cooling. Two tests were set up to measure the cooling performance and current sharing of these devices.

The first test was done with approximately 0.7V input-to-output and 1A per device. This gave a 700 milliwatt dissipation in each device and a 2A output current. The temperature rise above ambient is approximately 28°C and both devices were within plus or minus 1°C. Both the thermal and electrical sharing of these devices is excellent. The thermograph in Figure 5 shows the temperature distribution between these devices and the PC board reaches ambient temperature within about a half an inch from the devices.

The power is then increased with 1.7V across each device. This gives 1.7 watts dissipation in each device and a device

temperature of about 90°C, about 65°C above ambient as shown in Figure 6. Again, the temperature matching between the devices is within 2°C, showing excellent tracking between the devices. The board temperature has reached approximately 40°C within about 0.75 inches of each device.

While 90°C is an acceptable operating temperature for these devices, this is in 25°C ambient. For higher ambients, the temperature must be controlled to prevent device temperature from exceeding 125°C. A 3-meter-per-second airflow across the devices will decrease the device temperature about 20°C providing a margin for higher operating ambient temperatures.

Both at low power and relatively high power levels devices can be paralleled for higher output current. Current sharing and thermal sharing is excellent, showing that acceptable operation can be had while keeping the peak temperatures below excessive operating temperatures on a board. This technique allows higher operating current linear regulation to be used in systems where it could never be used before.

Quieting the Noise

The LT3080 offers numerous advantages when it comes to dealing with noise. There are several sources of noise in a linear regulator. The most critical noise source for any LDO is the reference; from there, the noise contribution

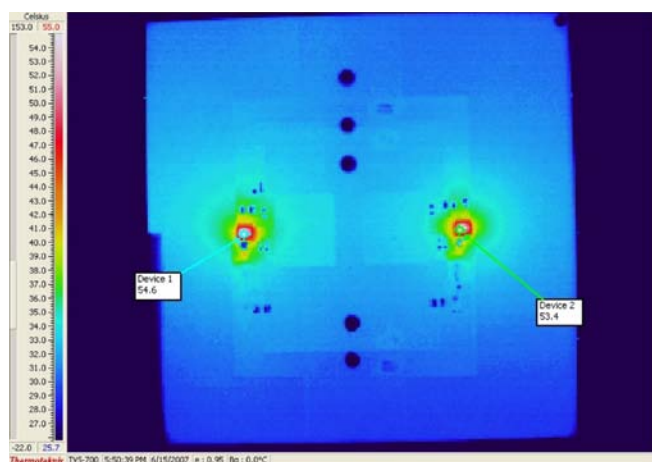


Figure 5. Temperature Rise at 700mW Dissipation

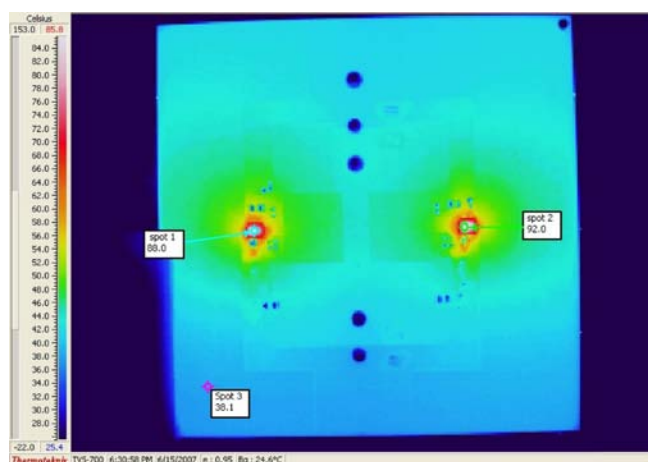


Figure 6. Temperature Rise at 1.7W Dissipation

APPLICATIONS INFORMATION

of the connections between the regulator and the load. The data sheet specification for load regulation is Kelvin sensed at the pins of the package. Negative side sensing is a true Kelvin connection, with the bottom of the voltage setting resistor returned to the negative side of the load (see Figure 7). Connected as shown, system load regulation will be the sum of the LT3080 load regulation and the parasitic line resistance multiplied by the output current. It is important to keep the positive connection between the regulator and load as short as possible and use large wire or PC board traces.

Thermal Considerations

The LT3080 has internal power and thermal limiting circuitry designed to protect it under overload conditions. For continuous normal load conditions, maximum junction temperature must not be exceeded. It is important to give consideration to all sources of thermal resistance from junction to ambient. This includes junction-to-case, case-to-heat sink interface, heat sink resistance or circuit board-to-ambient as the application dictates. Additional heat sources nearby must also be considered.

For surface mount devices, heat sinking is accomplished by using the heat spreading capabilities of the PC board and its copper traces. Surface mount heat sinks and plated through-holes can also be used to spread the heat generated by power devices.

Junction-to-case thermal resistance is specified from the IC junction to the bottom of the case directly below the die. This is the lowest resistance path for heat flow. Proper mounting is required to ensure the best possible thermal flow from this area of the package to the heat sinking material. For the TO-220 package, thermal compound is strongly recommended for mechanical connections to a heat sink. A thermally conductive spacer can be used for electrical isolation as long as the added contribution to thermal resistance is considered. **Note that the Tab or Exposed Pad (depending on package) is electrically connected to the output.**

The following tables list thermal resistance for several different copper areas given a fixed board size. All measurements were taken in still air on two-sided 1/16" FR-4 board with one ounce copper.

Table 2. MSE Package, 8-Lead MSOP

COPPER AREA		BOARD AREA	THERMAL RESISTANCE (JUNCTION-TO-AMBIENT)
TOPSIDE*	BACKSIDE		
2500mm ²	2500mm ²	2500mm ²	55°C/W
1000mm ²	2500mm ²	2500mm ²	57°C/W
225mm ²	2500mm ²	2500mm ²	60°C/W
100mm ²	2500mm ²	2500mm ²	65°C/W

*Device is mounted on topside

Table 3. DD Package, 8-Lead DFN

COPPER AREA		BOARD AREA	THERMAL RESISTANCE (JUNCTION-TO-AMBIENT)
TOPSIDE*	BACKSIDE		
2500mm ²	2500mm ²	2500mm ²	60°C/W
1000mm ²	2500mm ²	2500mm ²	62°C/W
225mm ²	2500mm ²	2500mm ²	65°C/W
100mm ²	2500mm ²	2500mm ²	68°C/W

*Device is mounted on topside

Table 4. ST Package, 3-Lead SOT-223

COPPER AREA		BOARD AREA	THERMAL RESISTANCE (JUNCTION-TO-AMBIENT)
TOPSIDE*	BACKSIDE		
2500mm ²	2500mm ²	2500mm ²	48°C/W
1000mm ²	2500mm ²	2500mm ²	48°C/W
225mm ²	2500mm ²	2500mm ²	56°C/W
100mm ²	2500mm ²	2500mm ²	62°C/W

*Device is mounted on topside

Table 5. Q Package, 5-Lead DD-Pak

COPPER AREA		BOARD AREA	THERMAL RESISTANCE (JUNCTION-TO-AMBIENT)
TOPSIDE*	BACKSIDE		
2500mm ²	2500mm ²	2500mm ²	25°C/W
1000mm ²	2500mm ²	2500mm ²	30°C/W
125mm ²	2500mm ²	2500mm ²	35°C/W

*Device is mounted on topside

T Package, 5-Lead TO-220

Thermal Resistance (Junction-to-Case) = 3°C/W

Calculating Junction Temperature

Example: Given an output voltage of 0.9V, a V_{CONTROL} voltage of $3.3V \pm 10\%$, an I_{N} voltage of $1.5V \pm 5\%$, output current range from 1mA to 1A and a maximum ambient temperature of 50°C, what will the maximum junction temperature be for the DFN package on a 2500mm² board with topside copper area of 500mm²?

APPLICATIONS INFORMATION

The power in the drive circuit equals:

$$P_{\text{DRIVE}} = (V_{\text{CONTROL}} - V_{\text{OUT}})(I_{\text{CONTROL}})$$

where I_{CONTROL} is equal to $I_{\text{OUT}}/60$. I_{CONTROL} is a function of output current. A curve of I_{CONTROL} vs I_{OUT} can be found in the Typical Performance Characteristics curves.

The power in the output transistor equals:

$$P_{\text{OUTPUT}} = (V_{\text{IN}} - V_{\text{OUT}})(I_{\text{OUT}})$$

The total power equals:

$$P_{\text{TOTAL}} = P_{\text{DRIVE}} + P_{\text{OUTPUT}}$$

The current delivered to the SET pin is negligible and can be ignored.

$$V_{\text{CONTROL(MAX CONTINUOUS)}} = 3.630\text{V} (3.3\text{V} + 10\%)$$

$$V_{\text{IN(MAX CONTINUOUS)}} = 1.575\text{V} (1.5\text{V} + 5\%)$$

$$V_{\text{OUT}} = 0.9\text{V}, I_{\text{OUT}} = 1\text{A}, T_A = 50^\circ\text{C}$$

Power dissipation under these conditions is equal to:

$$P_{\text{DRIVE}} = (V_{\text{CONTROL}} - V_{\text{OUT}})(I_{\text{CONTROL}})$$

$$I_{\text{CONTROL}} = \frac{I_{\text{OUT}}}{60} = \frac{1\text{A}}{60} = 17\text{mA}$$

$$P_{\text{DRIVE}} = (3.630\text{V} - 0.9\text{V})(17\text{mA}) = 46\text{mW}$$

$$P_{\text{OUTPUT}} = (V_{\text{IN}} - V_{\text{OUT}})(I_{\text{OUT}})$$

$$P_{\text{OUTPUT}} = (1.575\text{V} - 0.9\text{V})(1\text{A}) = 675\text{mW}$$

$$\text{Total Power Dissipation} = 721\text{mW}$$

Junction Temperature will be equal to:

$$T_J = T_A + P_{\text{TOTAL}} \cdot \theta_{JA} \text{ (approximated using tables)}$$

$$T_J = 50^\circ\text{C} + 721\text{mW} \cdot 64^\circ\text{C/W} = 96^\circ\text{C}$$

In this case, the junction temperature is below the maximum rating, ensuring reliable operation.

Reducing Power Dissipation

In some applications it may be necessary to reduce the power dissipation in the LT3080 package without sacrificing output current capability. Two techniques are available. The first technique, illustrated in Figure 8, employs a resistor in series with the regulator's input. The voltage drop across R_S decreases the LT3080's IN-to-OUT differential voltage and correspondingly decreases the LT3080's power dissipation.

As an example, assume: $V_{\text{IN}} = V_{\text{CONTROL}} = 5\text{V}$, $V_{\text{OUT}} = 3.3\text{V}$ and $I_{\text{OUT(MAX)}} = 1\text{A}$. Use the formulas from the Calculating Junction Temperature section previously discussed.

Without series resistor R_S , power dissipation in the LT3080 equals:

$$P_{\text{TOTAL}} = (5\text{V} - 3.3\text{V}) \cdot \left(\frac{1\text{A}}{60}\right) + (5\text{V} - 3.3\text{V}) \cdot 1\text{A} = 1.73\text{W}$$

If the voltage differential (V_{DIFF}) across the NPN pass transistor is chosen as 0.5V, then R_S equals:

$$R_S = \frac{5\text{V} - 3.3\text{V} - 0.5\text{V}}{1\text{A}} = 1.2\Omega$$

Power dissipation in the LT3080 now equals:

$$P_{\text{TOTAL}} = (5\text{V} - 3.3\text{V}) \cdot \left(\frac{1\text{A}}{60}\right) + (0.5\text{V}) \cdot 1\text{A} = 0.53\text{W}$$

The LT3080's power dissipation is now only 30% compared to no series resistor. R_S dissipates 1.2W of power. Choose appropriate wattage resistors to handle and dissipate the power properly.

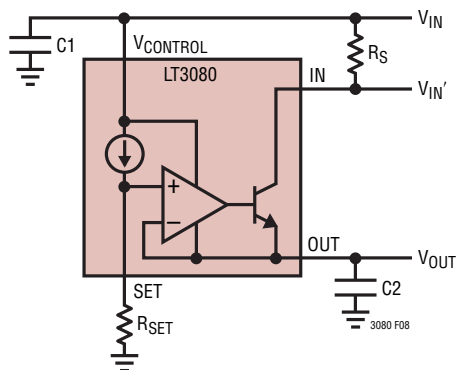


Figure 8. Reducing Power Dissipation Using a Series Resistor

APPLICATIONS INFORMATION

The second technique for reducing power dissipation, shown in Figure 9, uses a resistor in parallel with the LT3080. This resistor provides a parallel path for current flow, reducing the current flowing through the LT3080. This technique works well if input voltage is reasonably constant and output load current changes are small. This technique also increases the maximum available output current at the expense of minimum load requirements.

As an example, assume: $V_{IN} = V_{CONTROL} = 5V$, $V_{IN(MAX)} = 5.5V$, $V_{OUT} = 3.3V$, $V_{OUT(MIN)} = 3.2V$, $I_{OUT(MAX)} = 1A$ and $I_{OUT(MIN)} = 0.7A$. Also, assuming that R_P carries no more than 90% of $I_{OUT(MIN)} = 630mA$.

Calculating R_P yields:

$$R_P = \frac{5.5V - 3.2V}{0.63A} = 3.65\Omega$$

(5% Standard value = 3.6Ω)

The maximum total power dissipation is $(5.5V - 3.2V) \cdot 1A = 2.3W$. However the LT3080 supplies only:

$$1A - \frac{5.5V - 3.2V}{3.6\Omega} = 0.36A$$

Therefore, the LT3080's power dissipation is only:

$$P_{DIS} = (5.5V - 3.2V) \cdot 0.36A = 0.83W$$

R_P dissipates 1.47W of power. As with the first technique, choose appropriate wattage resistors to handle and dissipate the power properly. With this configuration, the LT3080 supplies only 0.36A. Therefore, load current can increase by 0.64A to 1.64A while keeping the LT3080 in its normal operating range.

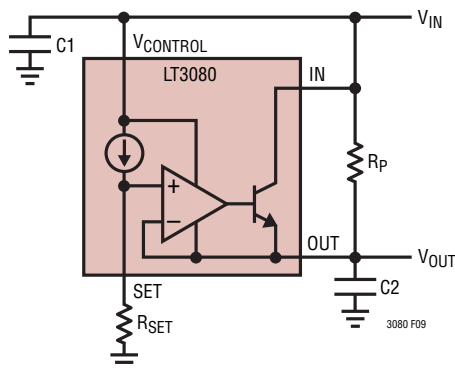
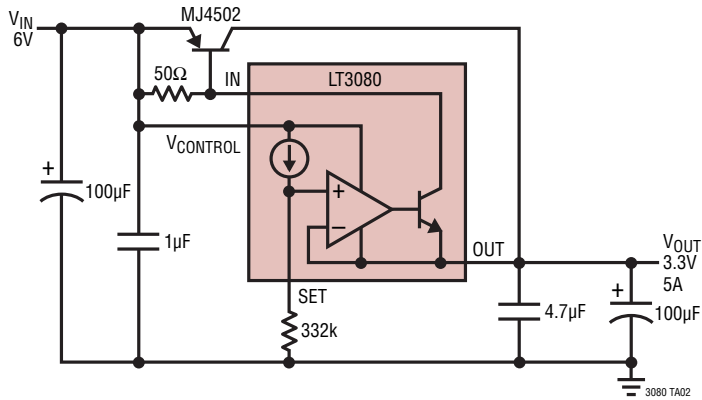


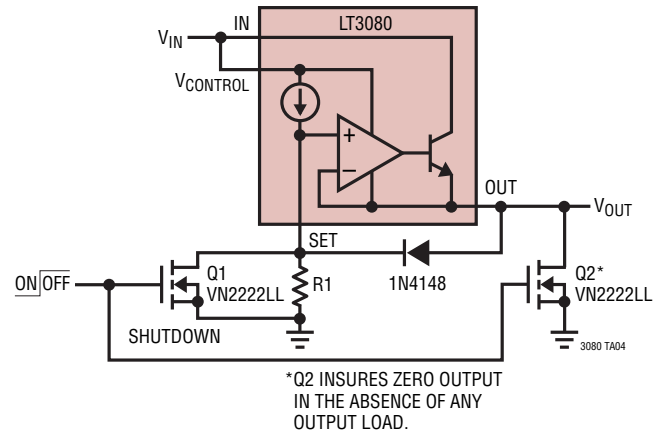
Figure 9. Reducing Power Dissipation Using a Parallel Resistor

TYPICAL APPLICATIONS

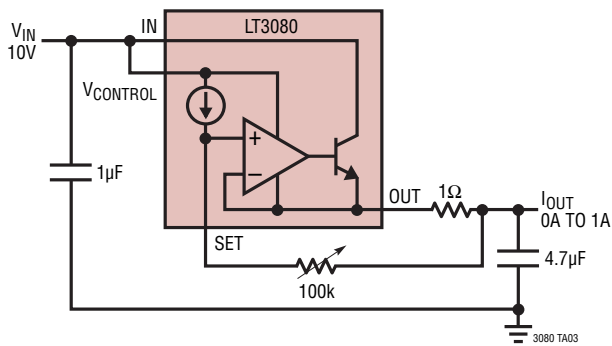
Higher Output Current



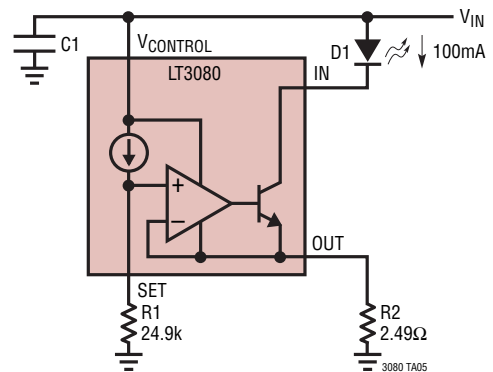
Adding Shutdown



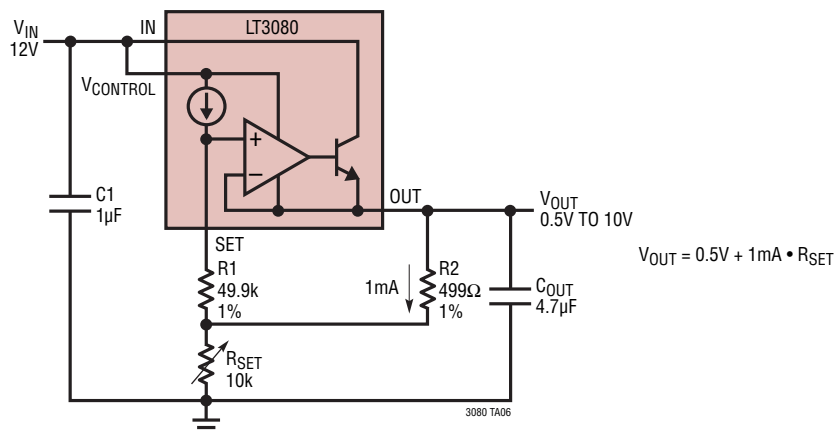
Current Source



Low Dropout Voltage LED Driver

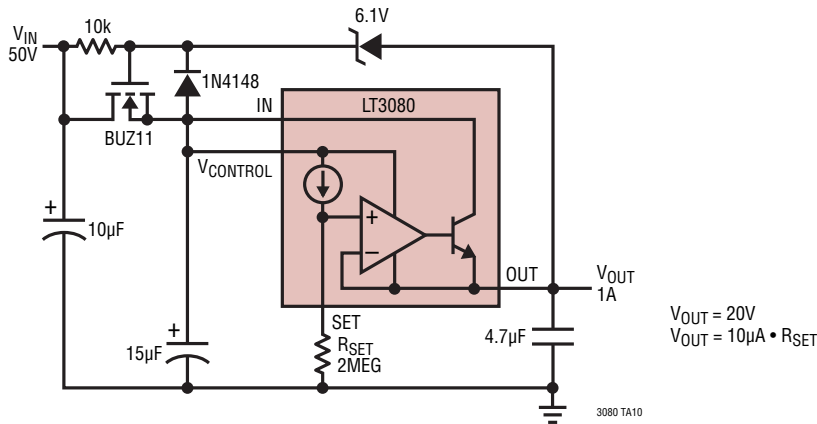


Using a Lower Value SET Resistor

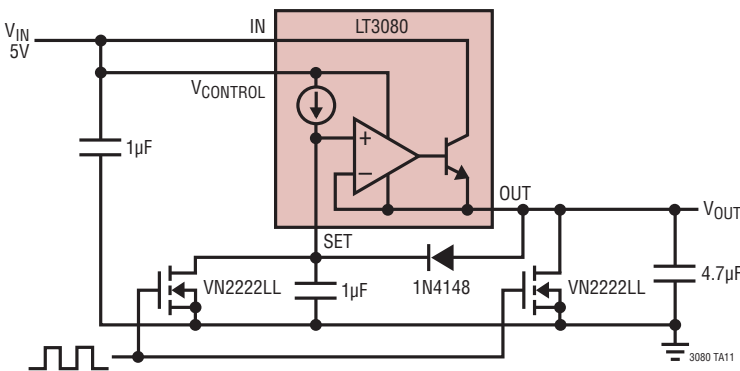


TYPICAL APPLICATIONS

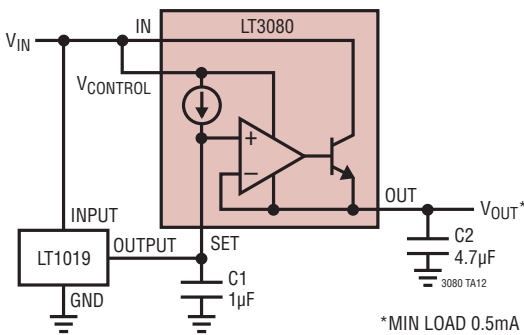
High Voltage Regulator



Ramp Generator

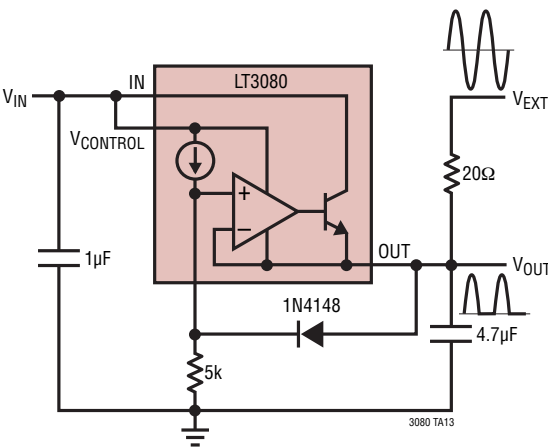


Reference Buffer

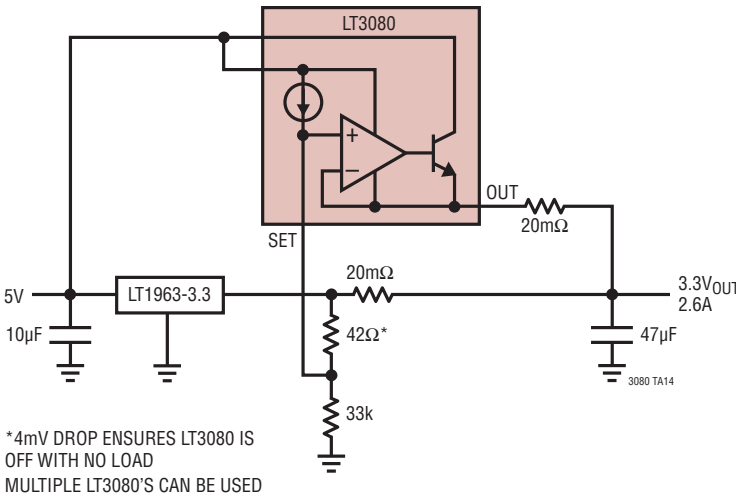


*MIN LOAD 0.5mA

Ground Clamp



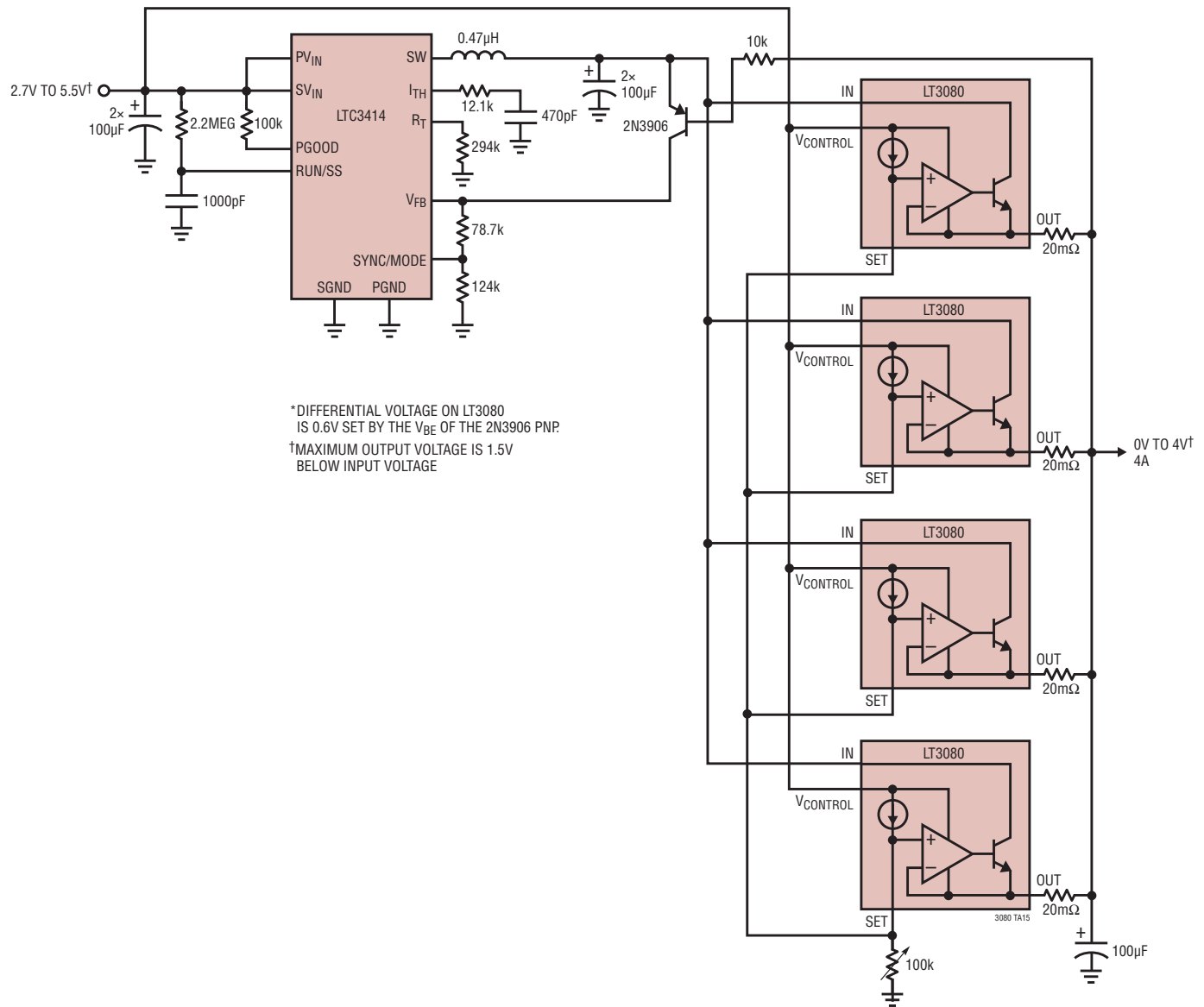
Boosting Fixed Output Regulators



*4mV DROP ENSURES LT3080 IS OFF WITH NO LOAD
 MULTIPLE LT3080'S CAN BE USED

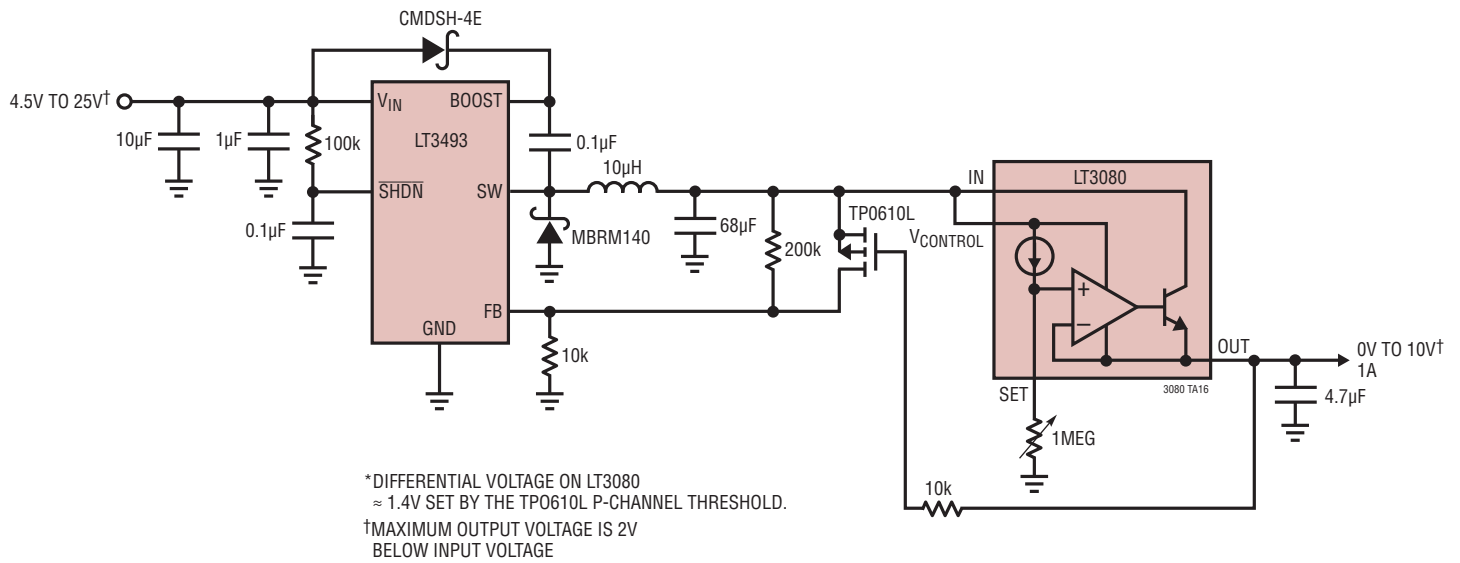
TYPICAL APPLICATIONS

Low Voltage, High Current Adjustable High Efficiency Regulator*

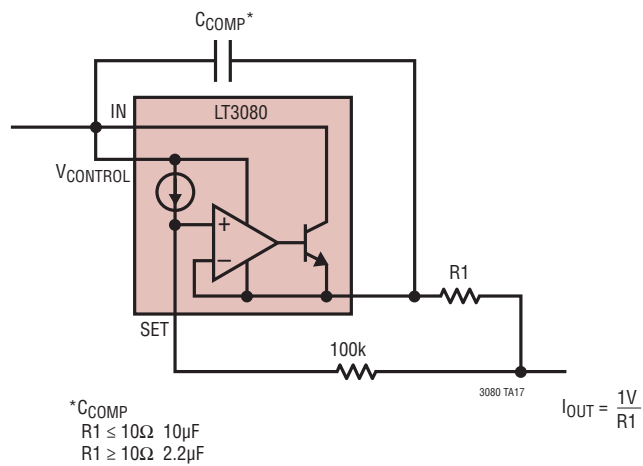


TYPICAL APPLICATIONS

Adjustable High Efficiency Regulator*

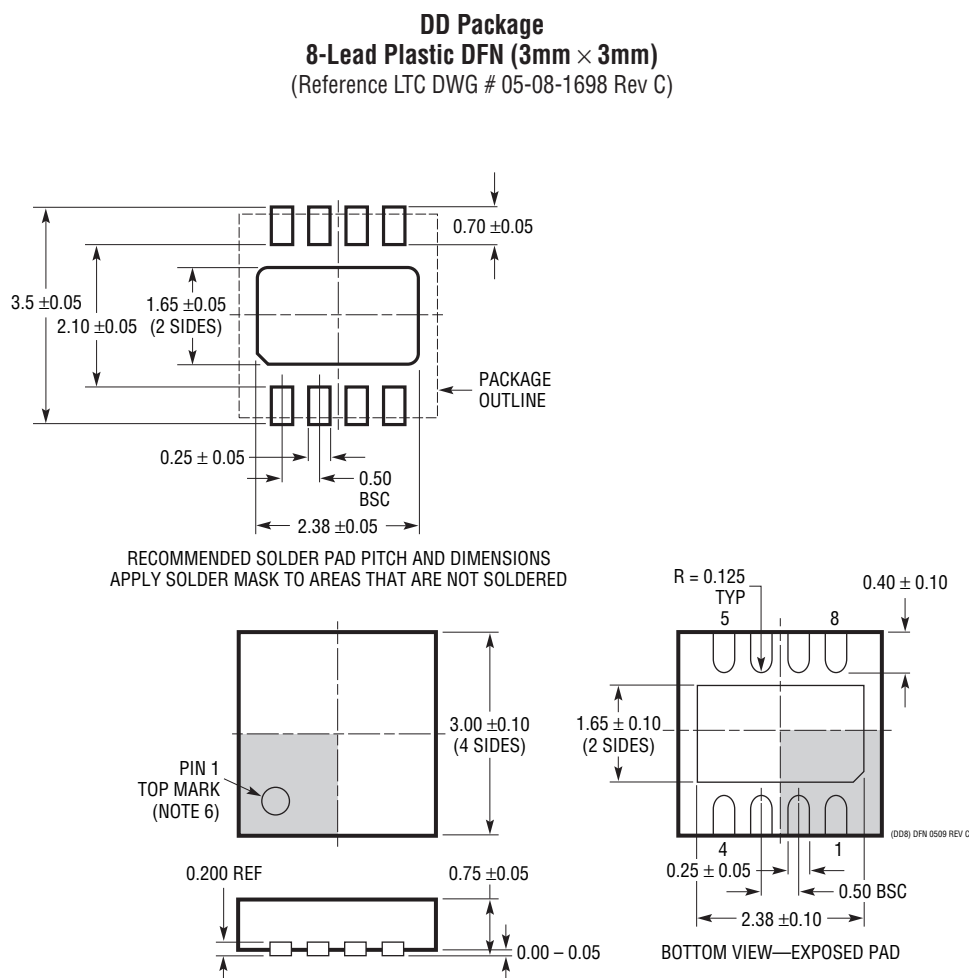


2 Terminal Current Source



PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.



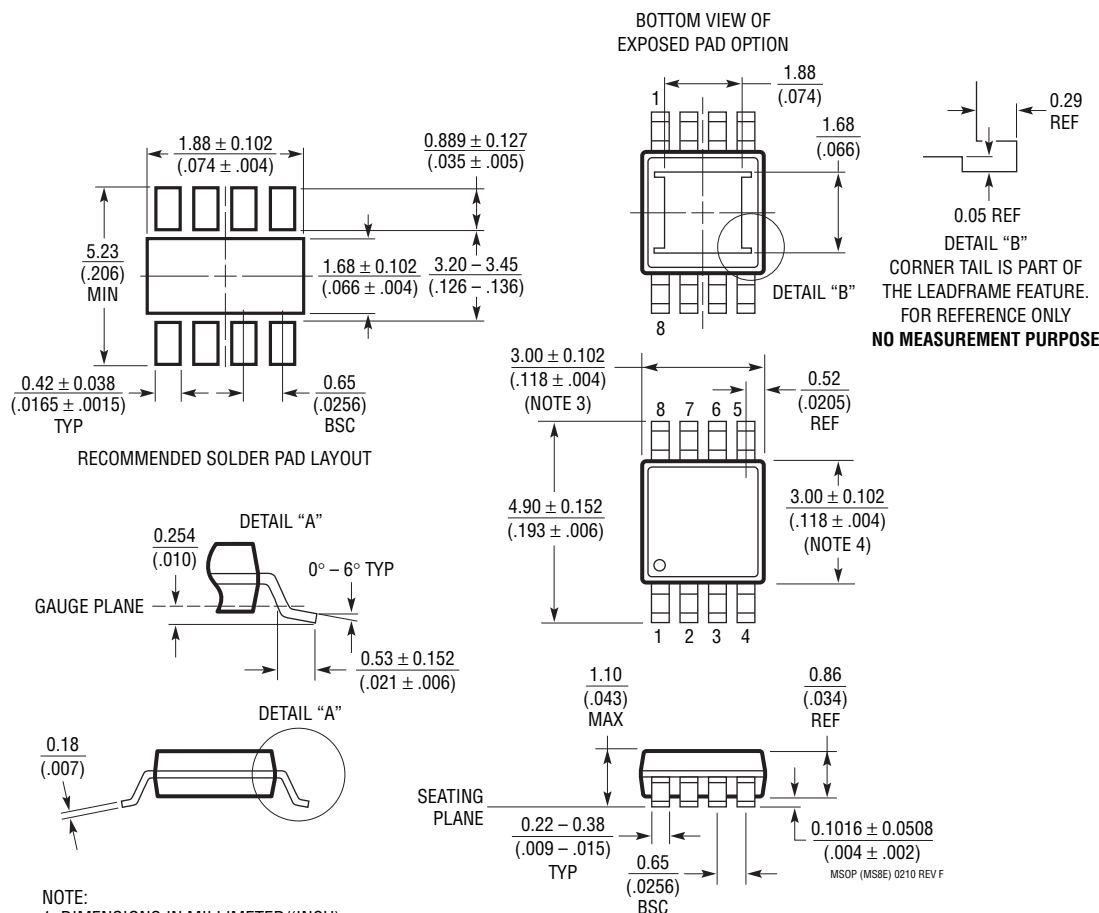
NOTE:

1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE M0-229 VARIATION OF (WEED-1)
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON TOP AND BOTTOM OF PACKAGE

PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

MS8E Package 8-Lead Plastic MSOP, Exposed Die Pad (Reference LTC DWG # 05-08-1662 Rev F)



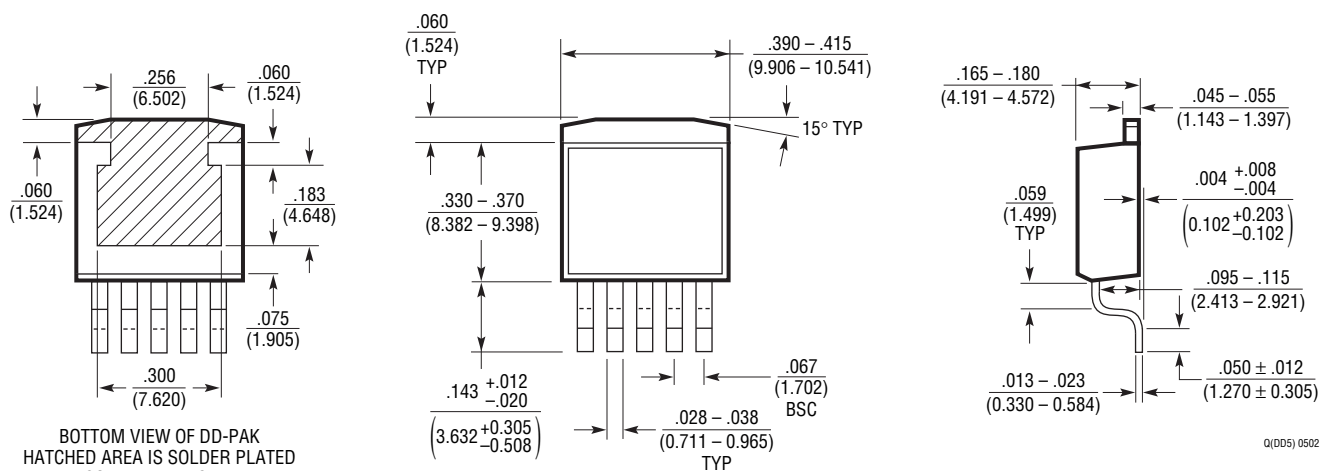
NOTE:

1. DIMENSIONS IN MILLIMETER/(INCH)
2. DRAWING NOT TO SCALE
3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX
6. EXPOSED PAD DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH ON E-PAD SHALL NOT EXCEED 0.254mm (.010") PER SIDE.

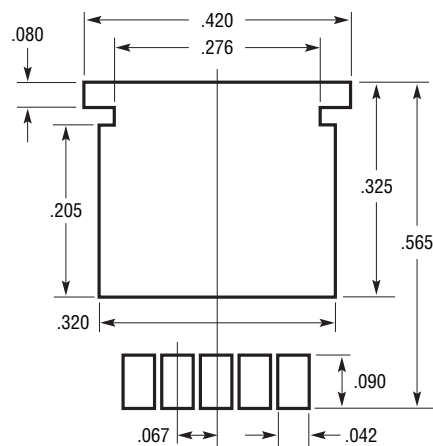
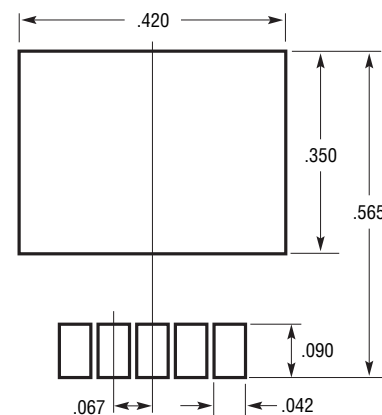
PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

Q Package
5-Lead Plastic DD-Pak
 (Reference LTC DWG # 05-08-1461)



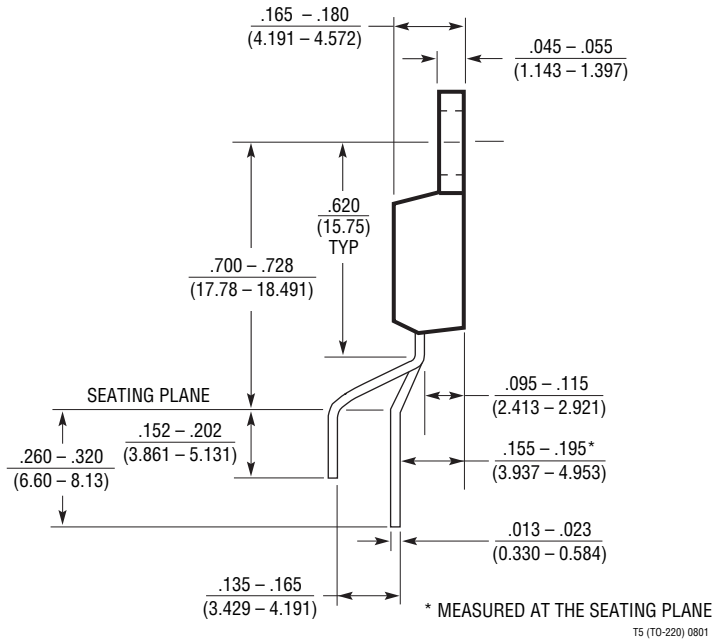
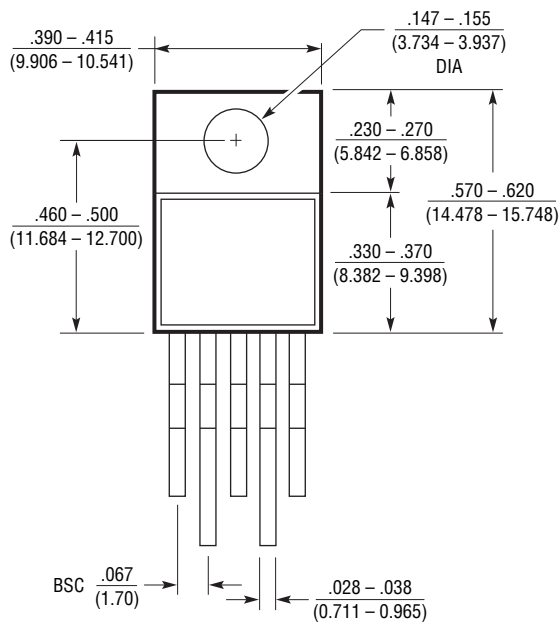
Q(DD5) 0502



PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

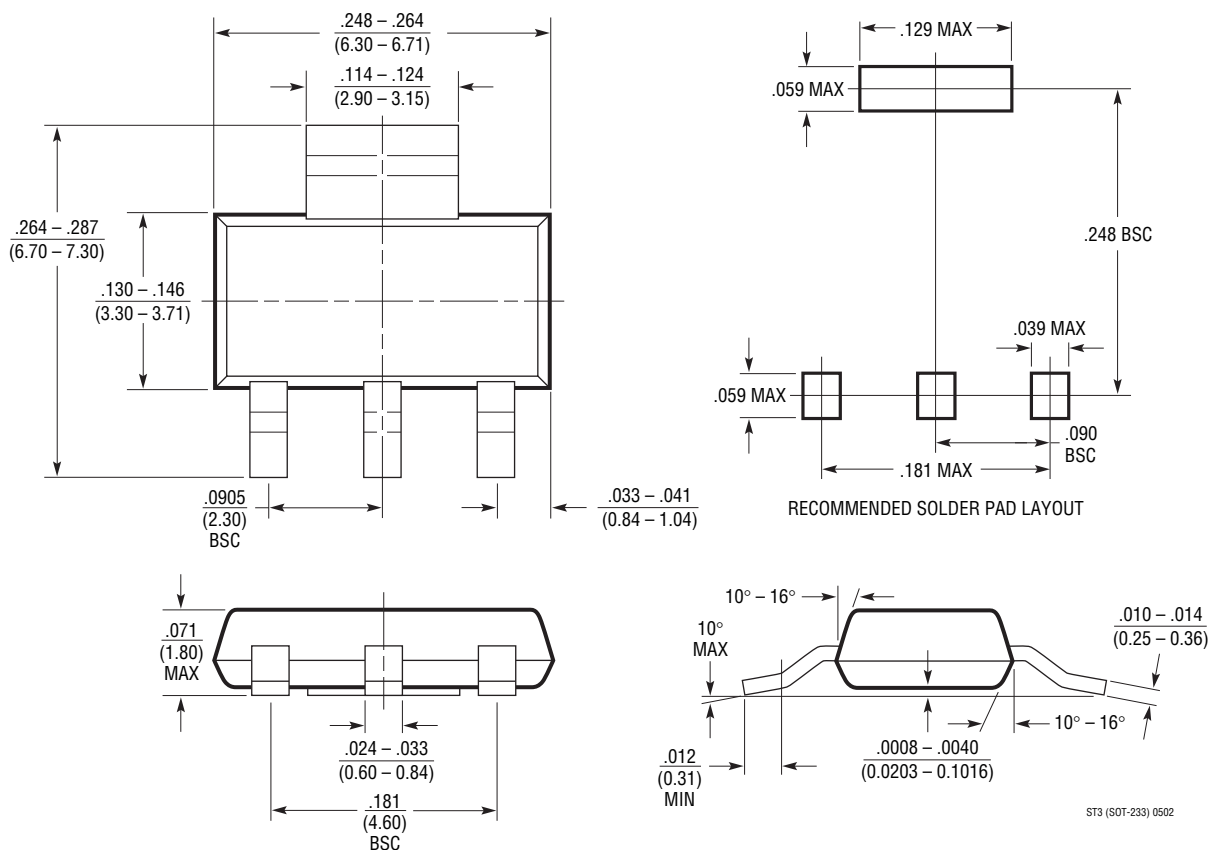
T Package 5-Lead Plastic TO-220 (Standard) (Reference LTC DWG # 05-08-1421)



PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

ST Package
3-Lead Plastic SOT-223
 (Reference LTC DWG # 05-08-1630)

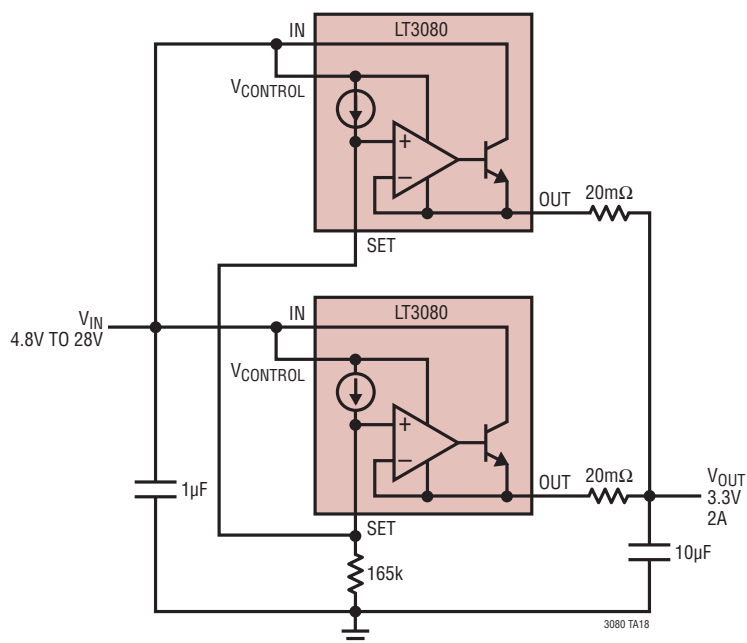


REVISION HISTORY (Revision history begins at Rev B)

REV	DATE	DESCRIPTION	PAGE NUMBER
B	6/10	Made minor updates to Features and Description sections	1
		Revised Line Regulation Conditions and Note 2	3
		Made minor text edits in Applications Information section	9
		Added 200k resistor to drawing 3080 TA19 in Typical Applications section	20
		Updated Package Description drawings	21, 22
C	9/11	Added I-grade information to the Absolute Maximum Ratings section and the Order Information table.	2
		Updated Note 2.	3

TYPICAL APPLICATION

Paralleling Regulators



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LDOs		
LT1086	1.5A Low Dropout Regulator	Fixed 2.85V, 3.3V, 3.6V, 5V and 12V Output
LT1117	800mA Low Dropout Regulator	1V Dropout, Adjustable or Fixed Output, DD-Pak, SOT-223 Packages
LT1118	800mA Low Dropout Regulator	OK for Sinking and Sourcing, SO-8 and SOT-223 Packages
LT1963A	1.5A Low Noise, Fast Transient Response LDO	340mV Dropout Voltage, Low Noise: 40µV _{RMS} , V _{IN} = 2.5V to 20V, TO-220, DD-Pak, SOT-223 and SO-8 Packages
LT1965	1.1A Low Noise LDO	290mV Dropout Voltage, Low Noise 40µV _{RMS} , V _{IN} = 1.8V to 20V, V _{OUT} = 1.2V to 19.5V, Stable with Ceramic Caps TO-220, DD-Pak, MSOP and 3mm × 3mm DFN packages.
LTC®3026	1.5A Low Input Voltage VLDO™ Regulator	V _{IN} : 1.14V to 3.5V (Boost Enabled), 1.14V to 5.5V (with External 5V), V _{DO} = 0.1V, I _Q = 950µA, Stable with 10µF Ceramic Capacitors, 10-Lead MSOP and DFN Packages
Switching Regulators		
LT1976	High Voltage, 1.5A Step-Down Switching Regulator	f = 200kHz, I _Q = 100µA, TSSOP-16E Package
LTC3414	4A (I _{OUT}), 4MHz Synchronous Step-Down DC/DC Converter	95% Efficiency, V _{IN} : 2.25V to 5.5V, V _{OUT(MIN)} = 0.8V, TSSOP Package
LTC3406/LTC3406B	600mA (I _{OUT}), 1.5MHz Synchronous Step-Down DC/DC Converter	95% Efficiency, V _{IN} : 2.5V to 5.5V, V _{OUT(MIN)} = 0.6V, I _Q = 20µA, I _{SD} < 1µA, ThinSOT™ Package
LTC3411	1.25A (I _{OUT}), 4MHz Synchronous Step-Down DC/DC Converter	95% Efficiency, V _{IN} : 2.5V to 5.5V, V _{OUT(MIN)} = 0.8V, I _Q = 60µA, I _{SD} < 1µA, 10-Lead MS or DFN Packages